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FPBL15SM60

Smart Power Module (SPM)

General Description

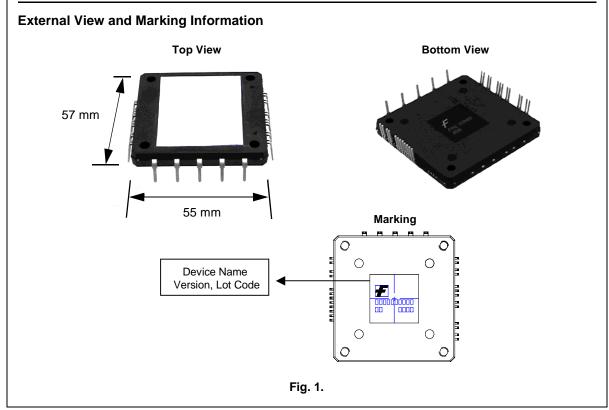
FPBL15SM60 is an advanced smart power module (SPM) that Fairchild has newly developed and designed to provide very compact and low cost, yet high performance ac motor drives mainly targeting medium speed low-power inverterdriven application like air conditioners. It combines optimized circuit protection and drive matched to low-loss IGBTs. Highly effective short-circuit current detection/ protection is realized through the use of advanced current sensing IGBT chips that allow continuous monitoring of the IGBTs current. System reliability is further enhanced by the integrated under-voltage lock-out protection. The high speed built-in HVIC provides opto-coupler-less IGBT gate driving capability that further reduce the overall size of the inverter system design. In addition the incorporated HVIC facilitates the use of single-supply drive topology enabling the FPBL15SM60 to be driven by only one drive supply voltage without negative bias.

Features

- UL Certified No. E209204
- 600V-15A 3-phase IGBT inverter bridge including control ICs for gate driving and protection
- Single-grounded power supply due to built-in HVIC
- Typical switching frequency of 7kHz
- Inverter power rating of 1kW / 100~253 Vac
- Isolation rating of 2500Vrms/min.
- Very low leakage current due to using ceramic substrate
 Adjustable current protection level by varying series
- resistor value with sense-IGBTs

Applications

- AC 100V ~ 253V three-phase inverter drive for small power (1kW) ac motor drives
- Home appliances applications requiring medium switching frequency operation like air conditioners drive system
- Application ratings:
 - Power : 1kW / 100~253 Vac
 - Switching frequency : Typical 7kHz (PWM Control)
 - 100% load current : 7A (Irms)



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FPBL15SM60

Integrated Drive, Protection and System Control Functions · For inverter high-side IGBTs: Gate drive circuit, High voltage isolated high-speed level shifting Control circuit under-voltage (UV) protection Note) Available bootstrap circuit example is given in Figs. 10, 15 and 16. • For inverter low-side IGBTs: Gate drive circuit, Short circuit protection (SC) Control supply circuit under-voltage (UV) protection Fault signaling: Corresponding to a SC fault (Low-side IGBTs) or a UV fault (Low-side supply) Input interface: 5V CMOS/LSTTL compatible, Schmitt trigger input **Pin Configuration Top View** V_{S(U)} VB(U) Ο Ο ■ V_{CC(UH)} IN(UH) ■ V_{S(V)} IN_(WL) ∎ V_{B(V)} V_{FO} 📼 VCC(VH) CFOD = IN_(VH) C_{SC} = COM(H) R_{SC} = V_{S(W)} NC 🚥 - V_{B(W)} NC 🚥 Ο Ο VCC(WH) IN_(WH) NC 🕳 W V P Η υ Ν Fig. 2. **Pin Descriptions** Pin Name **Pin Number Pin Description** V_{CC(L)} Low-side Common Bias Voltage for IC and IGBTs Driving 1 2 COM(L) Low-side Common Supply Ground 3 Signal Input Terminal for Low-side U Phase IN_(UL) 4 IN_(VL) Signal Input Terminal for Low-side V Phase Signal Input Terminal for Low-side W Phase 5 IN_(WL) 6 V_{FO} Fault Output Terminal 7 Capacitor for Fault Output Duration Time Selection C_{FOD} C_{SC} Capacitor (Low-pass Filter) for Short-current Detection Input 8 Resistor for Short-circuit Current Detection 9 R_{SC} 10 NC No Connection

11 NC No Connection NC No Connection 12 W 13 Output Terminal for W Phase 14 V Output Terminal for V Phase 15 U Output Terminal for U Phase Negative DC-Link Input 16 Ν

Integrated Power Functions

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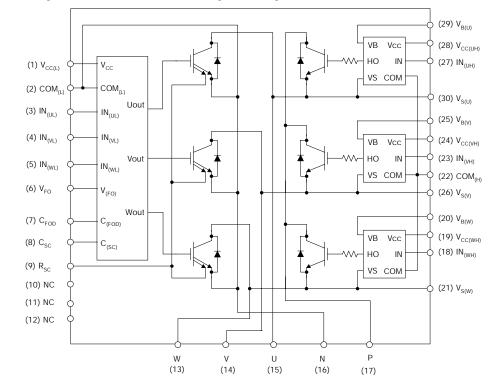
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• 600V-15A IGBT inverter for three-phase DC/AC power conversion (Please refer to Fig. 3)

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Pin Descr	Pin Descriptions (Continued)							
Pin Number	Pin Name	Pin Description						
17	Р	Positive DC-Link Input						
18	IN _(WH)	Signal Input Terminal for High-side W Phase						
19	V _{CC(WH)}	High-side Bias Voltage for W Phase IC						
20	V _{B(W)}	High-side Bias Voltage for W Phase IGBT Driving						
21	V _{S(W)}	High-side Bias Voltage Ground for W Phase IGBT Driving						
22	COM _(H)	High-side Common Supply Ground						
23	IN _(VH)	Signal Input Terminal for High-side V Phase						
24	V _{CC(VH)}	High-side Bias Voltage for V Phase IC						
25	V _{B(V)}	High-side Bias Voltage for V Phase IGBT Driving						
26	V _{S(V)}	High-side Bias Voltage Ground for V Phase IGBT Driving						
27	IN _(UH)	Signal Input Terminal for High-side U Phase						
28	V _{CC(UH)}	High-side Bias Voltage for U Phase IC						
29	V _{B(U)}	High-side Bias Voltage for U Phase IGBT Driving						
30	V _{S(U)}	High-side Bias Voltage Ground for U Phase IGBT Driving						

Internal Equivalent Circuit and Input/Output Pins



Note

Inverter low-side ((1) - (12) pins) is composed of three sense-IGBTs including freewheeling diodes for each IGBT and one control IC which has gate driving, current sensing and protection functions.
 Inverter power side ((13) - (17) pins) is composed of two inverter dc-link input terminals and three inverter output terminals.
 Inverter high-side ((18) - (30) pins) is composed of three normal-IGBTs including freewheeling diodes and three drive ICs for each IGBT.



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Absolute Maximum Ratings

Inverter Part ($T_C = 25^{\circ}C$, Unless Otherwise Specified)

Item	Symbol	Condition	Rating	Unit
Supply Voltage	V _{DC}	Applied to DC - Link	450	V
Supply Voltage (Surge)	V _{PN(Surge)}	Applied between P- N	500	V
Collector-Emitter Voltage	V _{CES}		600	V
Each IGBT Collector Current	± I _C	$T_{\rm C} = 25^{\circ}{\rm C}$ (Note Fig. 4)	15	A
Each IGBT Collector Current (Peak)	± I _{CP}	$T_{\rm C} = 25^{\circ}{\rm C}$ (Note Fig. 4)	30	A
Collector Dissipation	P _C	T _C = 25°C per One Chip	47	W
Operating Junction Temperature	TJ	(Note 1)	-55 ~ 150	°C

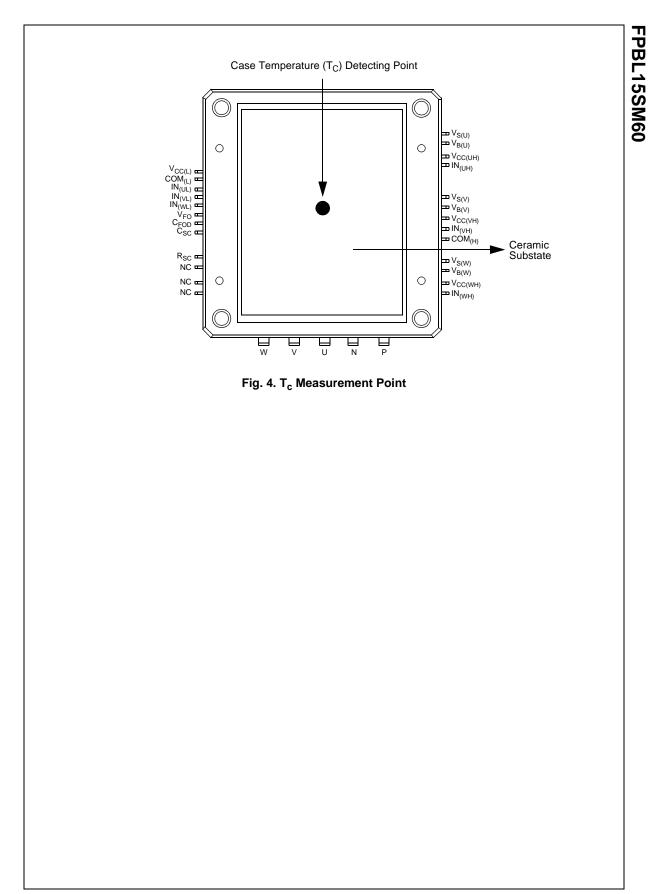
Note 1. It would be recommended that the average junction temperature should be limited to $T_J \le 125^{\circ}C$ (@ $T_C \le 100^{\circ}C$) in order to guarantee safe operation.

Control Part ($T_C = 25^{\circ}C$, Unless Otherwise Specified)

Item	Symbol	Condition	Rating	Unit
Control Supply Voltage	V _{CC}	Applied between $V_{CC(H)}$ - $COM_{(H)}$, $V_{CC(L)}$ - $COM_{(L)}$	18	V
High-side Control Bias Voltage	V _{BS}	Applied between $V_{B(U)}$ - $V_{S(U)}$, $V_{B(V)}$ - $V_{S(V)}$, $V_{B(W)}$ - $V_{S(W)}$	20	V
Input Signal Voltage	V _{IN}	Applied between $IN_{(UH)}$, $IN_{(VH)}$, $IN_{(WH)}$ - $COM_{(H)}$ $IN_{(UL)}$, $IN_{(VL)}$, $IN_{(WL)}$ - $COM_{(L)}$	-0.3 ~ 6.0	V
Fault Output Supply Voltage	V _{FO}	Applied between V _{FO} - COM _(L)	-0.3~V _{CC} +0.5	V
Fault Output Current	I _{FO}	Sink Current at V _{FO} Pin	5	mA
Current Sensing Input Voltage	V _{SC}	Applied between C _{SC} - COM _(L)	-0.3~V _{CC} +0.5	V

Total System

Item	Symbol	Condition	Rating	Unit
Self Protection Supply Voltage Limit (Short Circuit Protection Capability)	V _{DC(PROT)}	Applied to DC - Link, V _{CC} = V _{BS} = 13.5 ~ 16.5V T _J = 125°C, Non-repetitive, less than 6μs	400	V
Module Case Operation Temperature	Т _С	Note Fig. 4	-20 ~ 100	°C
Storage Temperature	T _{STG}		-55 ~ 150	°C
Isolation Voltage	V _{ISO}	60Hz, Sinusoidal, AC 1 minute, Connection Pins to Heat-sink Plate	2500	V _{rms}



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Absolute Maximum Ratings

Thermal Resistance

Item	Symbol	mbol Condition		Тур.	Max.	Unit
Junction to Case Thermal Resistance	R _{th(j-c)Q}	Each IGBT under Inverter Operating Condition (Note 2)	-	-	2.61	°C/W
	R _{th(j-c)F}	Each FWDi under Inverter Operating Condition (Note 2)	-	-	3.73	°C/W
Contact Thermal R _{th(c-f)}		Ceramic Substrate (per 1 Module) Thermal Grease Applied	-	-	0.06	°C/W

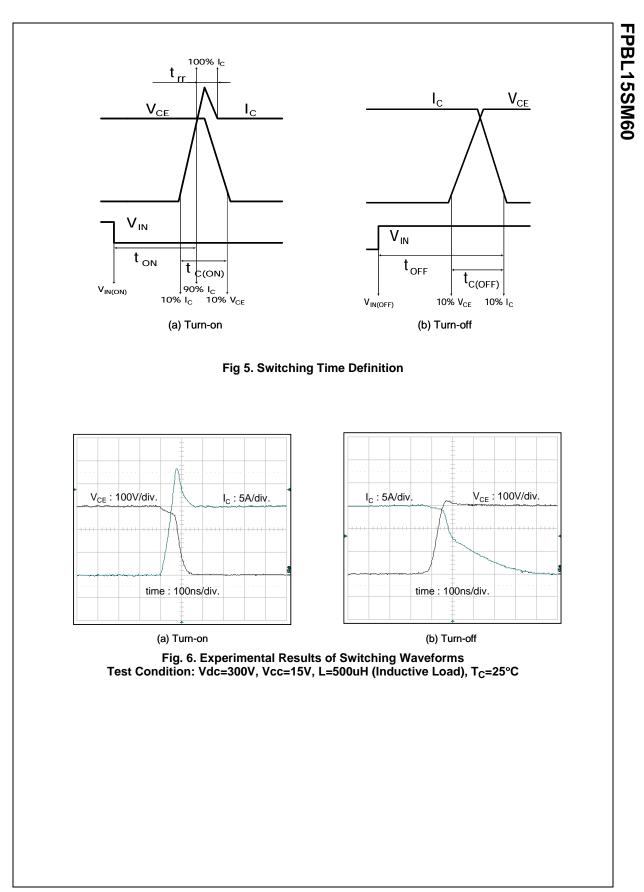
Note 2. For the measurement point of case temperature $(T_c),$ please refer to Fig. 4.

Electrical Characteristics

Inverter Part (T_j = 25°C, Unless Otherwise Specified)

Item	Symbol	Co	Condition			Max.	Unit
Collector - Emitter	V _{CE(SAT)}	$V_{CC} = V_{BS} = 15V$ $V_{IN} = 0V$	I _C = 15A, T _j = 25°C	-	-	2.5	V
Saturation Voltage	. ,	$V_{IN} = 0V$	I _C = 15A, T _j = 125°C	-	-	2.6	V
FWDi Forward Voltage	V _{FM}	$V_{IN} = 5V$ $I_{C} = 15A, T_{i} = 25^{\circ}C$			-	2.5	V
			I _C = 15A, T _j = 125°C	-	-	2.3	V
Switching Times	t _{ON}	$V_{PN} = 300V, V_{CC} = V_{BS} = 15V$ $I_C = 15A, T_j = 25^{\circ}C$ $V_{IN} = 5V \leftrightarrow 0V, Inductive Load$			0.39	-	μs
	t _{C(ON)}				0.12	-	μs
	t _{OFF}				0.72	-	μs
	t _{C(OFF)}	(High-Low Side)		-	0.39	-	μs
	t _{rr}	(Note 3)		-	0.1	-	μs
Collector - Emitter Leakage Current	I _{CES}	$V_{CE} = V_{CES}, T_j = 25^{\circ}C$		-	-	250	μA

Note
3. t_{ON} and t_{OFF} include the propagation delay time of the internal drive IC. t_{C(ON)} and t_{C(OFF)} are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Fig. 5.

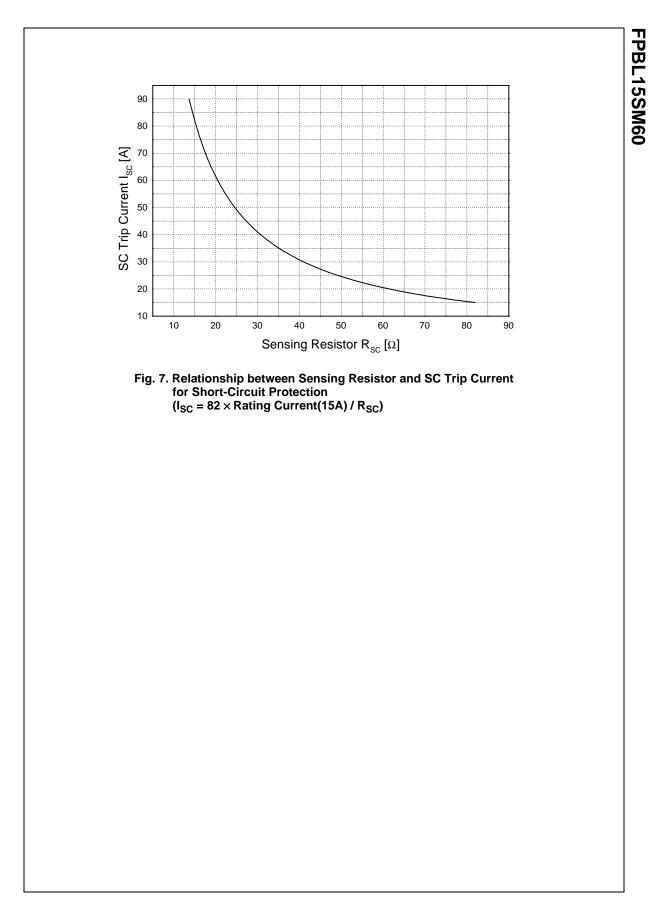


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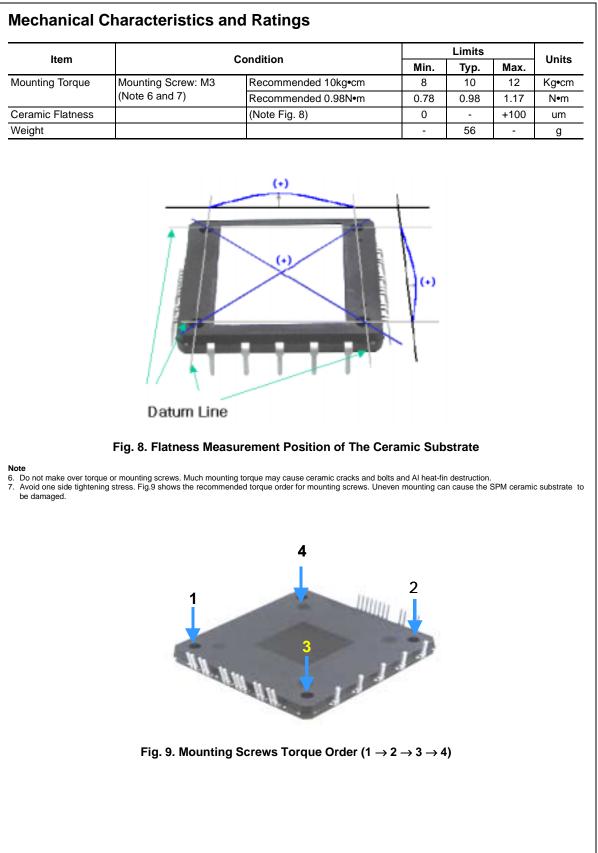
ltem	Symbol	Condition			Тур.	Max.	Unit
Control Supply Voltage	V _{CC}	Applied between V _{CC(H)} ,V _{CC(L)} - COM			15	16.5	V
High-Side Bias Voltage	V _{BS}	Applied between $V_{B(U)} - V_{S(U)}$, $V_{B(V)} - V_{S(V)}$, $V_{B(W)} - V_{S(W)}$			15	16.5	V
Quiescent V _{CC} Supply Current	I _{QCCL}	V _{CC} = 15V IN _(UL, VL, WL) = 5V	V _{CC(L)} - COM _(L)	-	-	26	mA
	IQCCH	V _{CC} = 15V IN _(UH, VH, WH) = 5V	$V_{CC(U)}, V_{CC(V)}, V_{CC(W)} - COM_{(H)}$	I	-	130	uA
Quiescent V _{BS} Supply Current	I _{QBS}			-	-	420	uA
Fault Output Voltage	V _{FOH}	V_{SC} = 0V, V_{FO} Circuit: 4.7k Ω to 5V Pull-up		4.5	-	-	V
	V _{FOL}	V_{SC} = 1V, V_{FO} Circuit: 4.7k Ω to 5V Pull-up		-	-	1.1	V
PWM Input Frequency	f _{PWM}	$T_C \leq 100^\circ C, \ T_J \leq 125^\circ$	-	7	-	kHz	
Allowable Input Signal Blanking Time Considering Leg Arm-Short	t _{dead}	-20°C ≤ T _C ≤ 100°C	3	-	-	us	
Short Circuit Trip Level	V _{SC(ref)}	$T_{J} = 25^{\circ}, V_{CC} = 15V$ (Note 4)		0.45	0.51	0.56	V
Sensing Voltage of IGBT Current	V _{SEN}	-20°C \leq T _C \leq 100°C, @ R _{SC} = 82 Ω and I _C = 15A (Note Fig. 7)			0.45	0.56	V
Supply Circuit Under-	UV _{CCD}	T _J ≤ 125°C	Detection Level	11.5	12	12.5	V
Voltage Protection	UV _{CCR}		Reset Level	12	12.5	13	V
	UV _{BSD}		Detection Level	7.3	9.0	10.8	V
	UV _{BSR}		Reset Level	8.6	10.3	12	V
Fault-Out Pulse Width	t _{FOD}	$V_{CC} = 15V, C(sc) = 1V$ $C_{FOD} = 33nF$ (Note 5)		1.4	1.8	2.0	ms
ON Threshold Voltage	V _{IN(ON)}	High-Side	Applied between IN _(UH) , IN _(VH) ,	-	-	0.8	V
OFF Threshold Voltage	V _{IN(OFF)}	IN _(WH) - COM _(H)		3.0	-	-	V
ON Threshold Voltage	V _{IN(ON)}	Low-Side Applied between IN _(UL) , IN _(VL) ,		-	-	0.8	V
OFF Threshold Voltage	V _{IN(OFF)}		IN _(WL) - COM _(L)	3.0	-	-	V

Electrical Characteristics

Note 4. Short-circuit current protection is functioning only at the low-sides. It would be recommended that the value of the external sensing resistor (R_{SC}) should be selected around 56 Ω in order to make the SC trip-level of about 20A. Please refer to Fig. 7 which shows the current sensing characteristics according to sensing resistor R_{SC} . 5. The fault-out pulse width t_{FOD} depends on the capacitance value of C_{FOD} according to the following approximate equation : $C_{FOD} = 18.3 \times 10^{-6} \times t_{FOD}[F]$

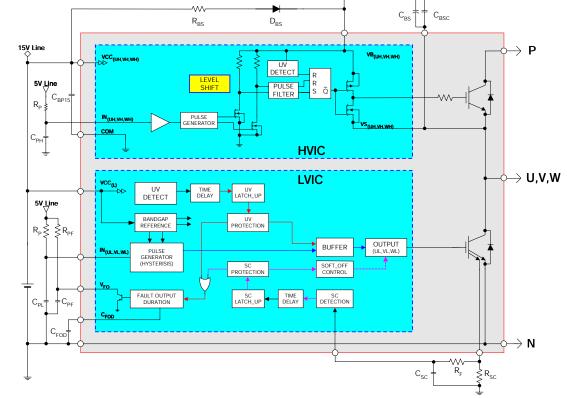


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Recommended Operating Conditions							
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ltem	Symbol	Condition	Min.	Тур.	Max.	Unit	
Supply Voltage	V _{PN}	Applied between P - N	-	300	400	V	
Control Supply Voltage	V _{CC}	Applied between $V_{CC(H)}$ - $COM_{(H)}$, $V_{CC(L)}$ - $COM_{(L)}$	13.5	15	16.5	V	
High-Side Bias Voltage	V_{BS}	Applied between V _{B(U)} - V _{S(U)} , V _{B(V)} - V _{S(V)} , V _{B(W)} - V _{S(W)}	13.5	15	16.5	V	
Blanking Time for Preventing Arm-short	t _{dead}	For Each Input Signal	3	-	-	us	
PWM Input Signal	f _{PWM}	$T_{C} \le 100^{\circ}C, T_{J} \le 125^{\circ}C$	-	7	-	kHz	
Input ON Threshold Voltage VIN(ON)		Applied between U _{IN} , V _{IN} , W _{IN} - COM 0 ~ 0.65		5	V		
Input OFF Threshold Voltage	V _{IN(OFF)}	Applied between U_{IN} , V_{IN} , W_{IN} - COM 4 ~ 5.5			V		

ICs Internal Structure and Input/Output Conditions

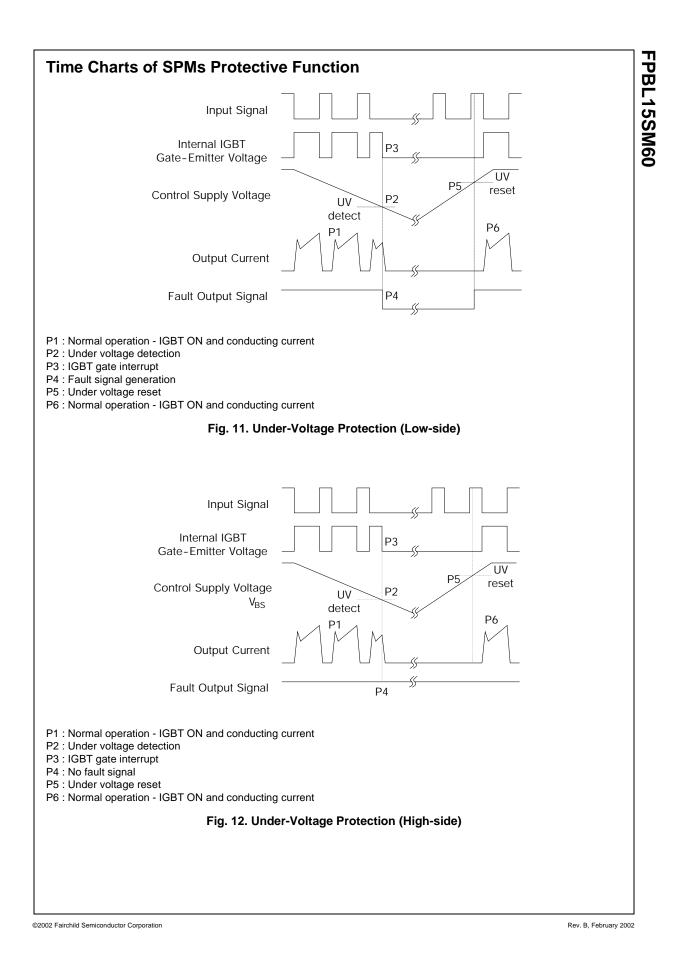


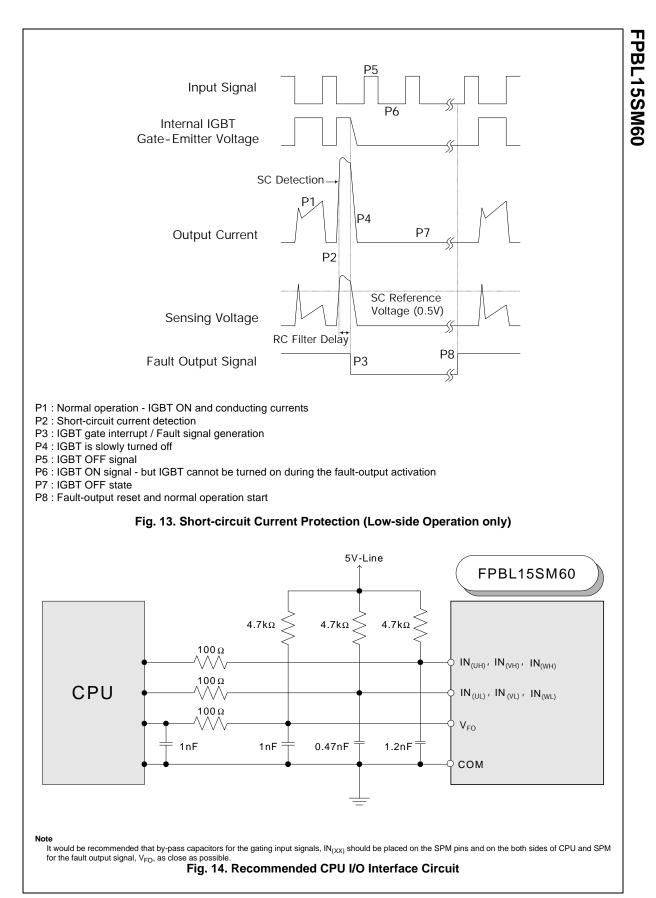
Note

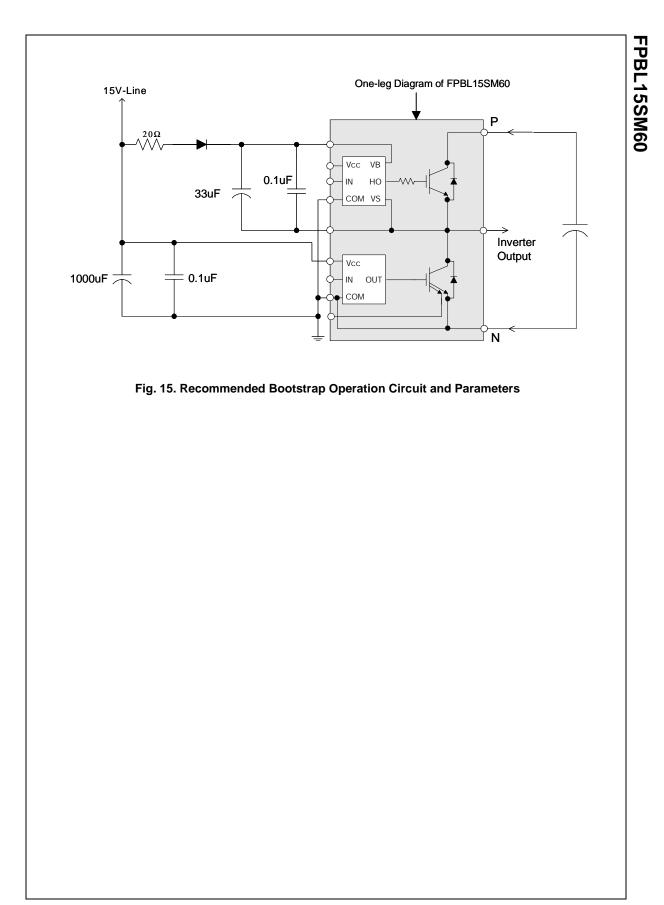
- One LVIC drives three Sense-IGBTs and can do short-circuit current protection also. Three sense emitters are commonly connected to R_{SC} terminal to detect short-circuit current. Low-side part of the inverter consists of three sense-IGBTs
- 2. One HVIC drives one normal-IGBT. High-side part of the inverter consists of three normal-IGBTs
- Each IC has under voltage detection and protection function.
 The logic input is compatible with standard CMOS or LSTTL outputs.
- R_pC_p coupling at each input/output is recommended in order to prevent the gating input/output signals oscillation and it should be as close as possible to each SPM gating input pin.
 It would be recommended that the bootstrap diode, D_{BS}, has soft and fast recovery characteristics.

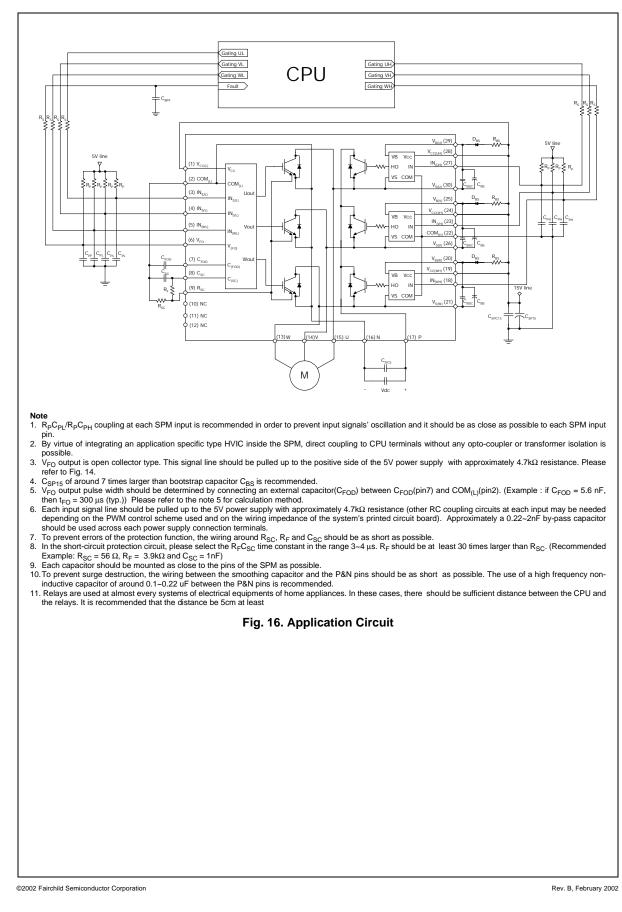
Fig. 10.

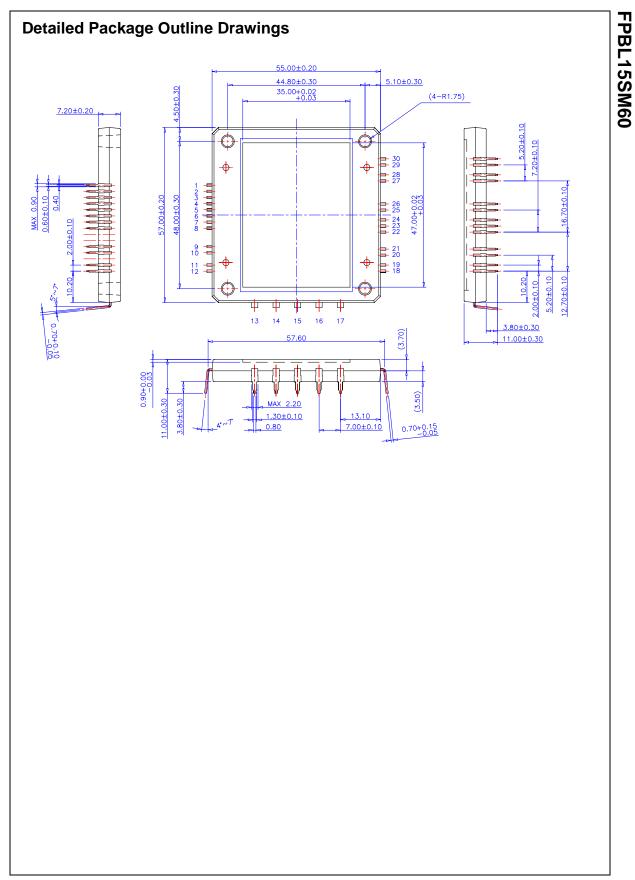
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